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Computational Efficiency for Kinetic Simulation of Vacuum Arcs

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Sandia National Labs

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Introduction



Vacuum arc discharge is a dominant failure mechanism in many vacuum electronic devices. The same basic failure mechanism is also described as high voltage breakdown (HVB), or electrostatic discharge (ESD). There are also numerous devices that operate based on intended discharge of an arc, e.g., plasma switches, spark plugs, and ion sources. In an effort to better understand the initiation process and post-breakdown evolution to a steady arc, we have developed a 3D massively parallel electrostatic low temperature plasma simulation tool, *Aleph. Aleph* includes a number of algorithm and model advances to understand the mechanisms and key phases of vacuum arc discharge. Our long-term goal is to provide predictive capability for breakdown in complex 3D vacuum devices in a production environment.

The spatial, temporal, and model capability demands for simulating vacuum arc discharges are enormous. The simulation must evolve from an initial collisionless vacuum (or near vacuum) state through a sputtering phase with surface interaction and low collisionality and ionization, into a growing quasi-neutral plasma with increasing collisionality and ionization, to an explosive growth electron avalanche process, and finally to a steady current-carrying arc plasma. The modeling demands change drastically as each of these phases is encountered. We describe a number of model advances to address these challenges.

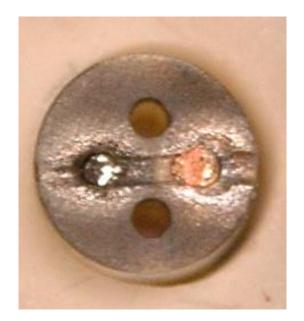
Outline

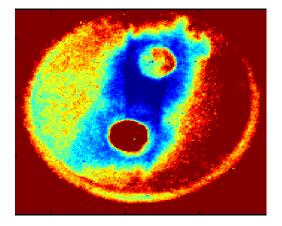


- Typical application
- Description of PIC-DSMC code, Aleph
- Simulation requirements & cost
- Successive refinement in Δx and Δt
- Particle merging
- Explicit adaptive particle move
- Dynamic sizing of DSMC cells
- Quasi-static acceleration

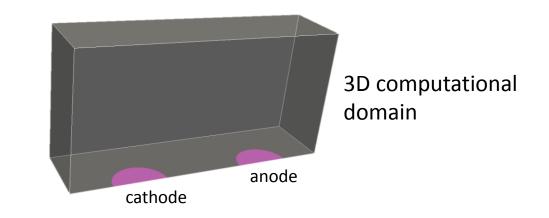
Typical Application







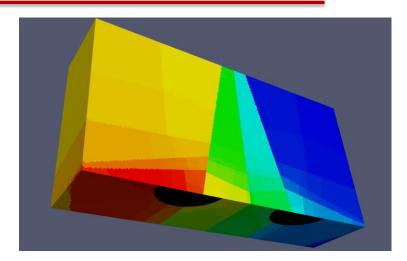
- In vacuum or 4 Torr Ar background
- 1.5 mm inner-to-inner distance
- 0.75 mm diameter electrodes
- Copper electrodes (this picture is Cu-Ti)
- 2 kV drop across electrodes
- 20Ω resistor in series
- Steady conditions around 50V, 100A
- Breakdown time << 100ns
- To meet an ionization mean free path of 1.5 mm at maximum σ , $n_i \simeq 10^{16} 10^{17} \, \text{#/cm}^3$





Description of Aleph

- 1, 2, or 3D Cartesian
- Unstructured FEM (compatible with CAD)
- Massively parallel
- Hybrid PIC + DSMC (PIC-MCC)
- Electrostatics
- Fixed B field
- Solid conduction
- e- approximations (quasi-neutral ambipolar, Boltzmann)
- Dual mesh (Particle and Electrostatics/Output)
- Advanced surface (electrode) physics models
- Collisions, charge exchange, chemistry, excited states, ionization
- Advanced particle weighting methods
- Dynamic load balancing (tricky)
- Restart (with all particles)
- Agile software infrastructure for extending BCs, post-processed quantities, etc.
- Currently utilizing up to 64K processors (>1B elements, >1B particles)





Description of Aleph

Basic algorithm for one time step of length Δt :

1. Given known electrostatic field \mathbf{E}^{n}_{t} move each particle for $\frac{\Delta t}{2}$ via:

$$v_i^{n+1/2} = v_i^n + \frac{\Delta t}{2} \left(\frac{q_i}{m_i} \mathbf{E}^n \right)$$

$$x_i = x_i + \Delta v_i$$

Compute intersections (non-trivial in parallel).

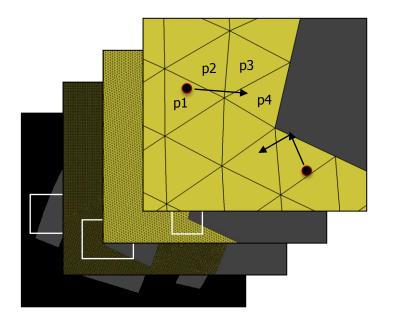
- 3. Transfer charges from particle mesh to static mesh.
- 4. Solve for \mathbf{E}^{n+1}

2.

$$abla \cdot (\epsilon \nabla V^{n+1}) = -\rho(\mathbf{x}^{n+1})$$

$$\mathbf{E}^{n+1} = -\nabla V^{n+1}$$

- 5. Transfer fields from static mesh to dynamic mesh.
- 6. Update each particle for another $\frac{\Delta t}{2}$ via: $v_i^{n+1} = v_i^{n+1/2} + \frac{\Delta t}{2} \left(\frac{q_i}{m_i} \mathbf{E}^{n+1} \right)$



- 7. Perform DSMC collisions: sample pairs in element, determine cross section and probability of collision. Roll a digital die, and if they collide, re-distribute energy.
- 8. Perform chemistry: for each reaction, determine expected number of reactions. Sample particles of those types, perform reaction (particle creation/deletion).
- 9. Reweight particles.
- 10. Compute post-processing and other quantities and write output.
- 11. Rebalance particle mesh if appropriate (variety of determination methods).

Simulation Requirements

<u>Temporal scales</u> dominated by plasma electron frequency ω_p , CFL, and collision frequency v_c at different phases of breakdown:

$$\Delta t < \min\left(\frac{2}{\omega_p}, \frac{\Delta x}{\sqrt{\frac{m_e \Delta V}{2q_e}}}, \frac{1}{n_n \sigma \bar{v}}\right)$$

<u>Spatial scales</u> dominated by Debye length λ_D and collision mean free path λ_{mfp} at different phases of breakdown:

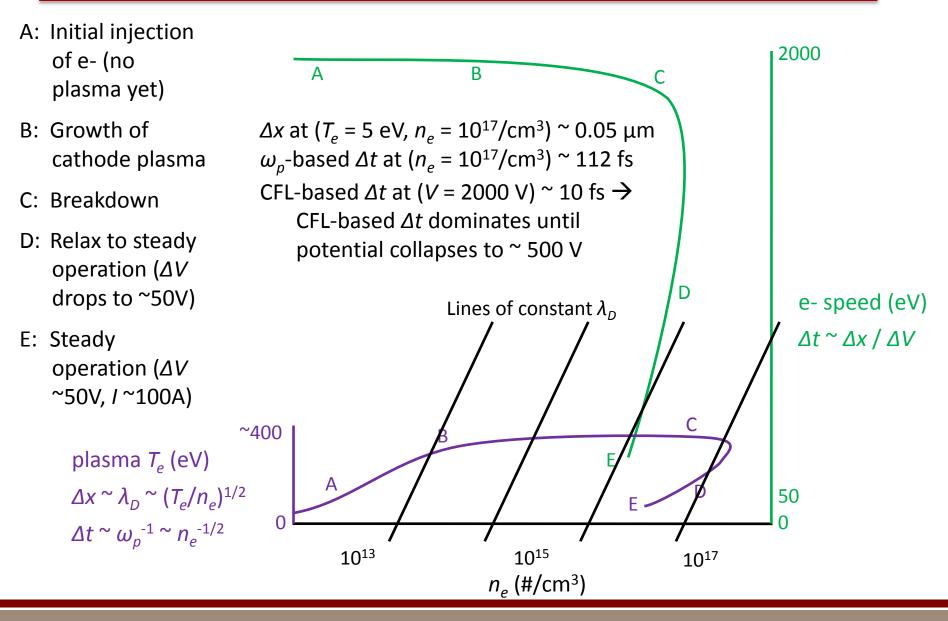
$$\Delta x < \min\left(\lambda_D, \frac{1}{n_n \sigma}\right)$$

<u>Number densities</u> increase from "0" to 10^{17} #/cm³. Using same fixed particle weight p_{weight} isn't an option.



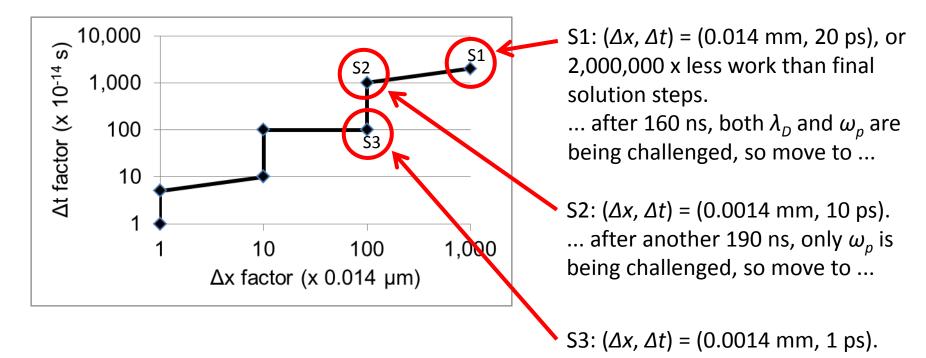
Typical Vacuum Arc Progression





Managing Δx , Δt : Successive Refinement

Discretely refine in $(\Delta x, \Delta t)$ by stopping simulation near stability/fidelity limits and perform full particle restart on Δx - and/or Δt -refined simulation. A typical progression to $(\Delta x, \Delta t) = (0.014 \ \mu m, 10 \ fs)$ looks like:

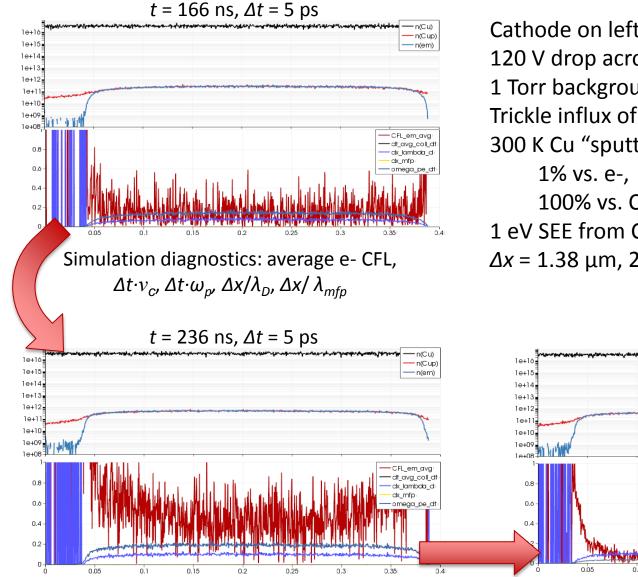


... and continue ... (just started dynamic global Δt selection, want to do something about Δx , too ...). Total savings to 1.35 μ s (this case) is tremendous, but still need many small steps on small mesh at end...

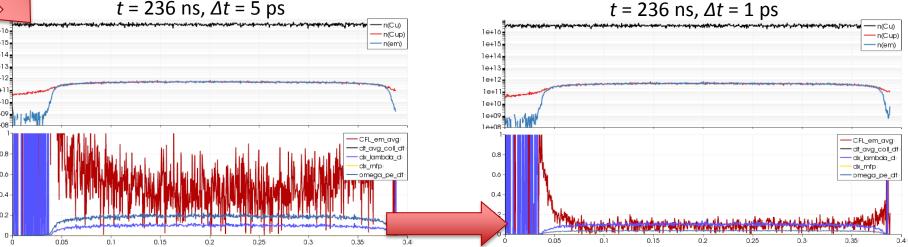




Managing Δx , Δt : Successive Refinement



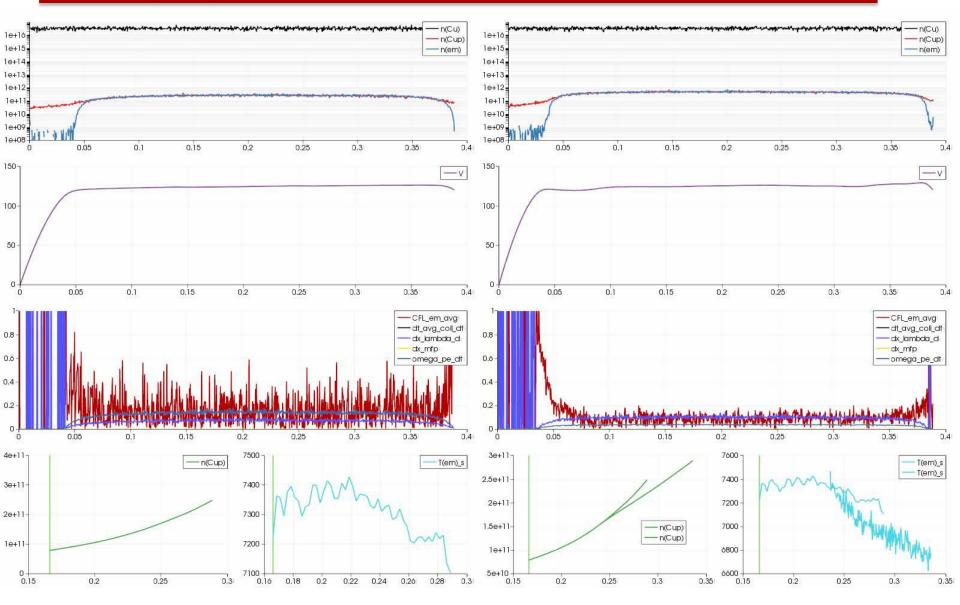
Cathode on left, anode on right, 120 V drop across 3.88 mm, 1 Torr background Cu, Trickle influx of cold e- $(10^{10} \#/cm^2/\mu s)$, 300 K Cu "sputters" at: 100% vs. Cu and Cu+, 1 eV SEE from Cu+ impact, $\Delta x = 1.38 \,\mu\text{m}$, 2812 cells.



Growing average e- CFL prompts restarting with smaller Δt .



Managing Δx , Δt : Successive Refinement



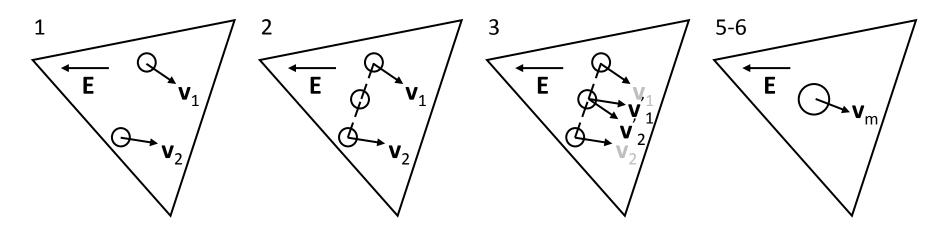
Managing p_{weight}: Particle Merging



We assume the discrete particle sample is the best representation of the "true" particle distribution. This drives us to use particle-only merge methods.

- 1. Choose a random pair of species *S* particles in the cell.
- 2. Compute center of mass position.
- 3. Compute modified velocities at the center of mass by accounting for displacement in the potential field.
- 4. If velocities are "too different," reject pair and repeat 1-3.
- 5. Calculate average velocity, conserving momentum.
- 6. Adjust (to target) weight and record difference in kinetic energy.

Repeat 1-6 until target number or limiter is met.



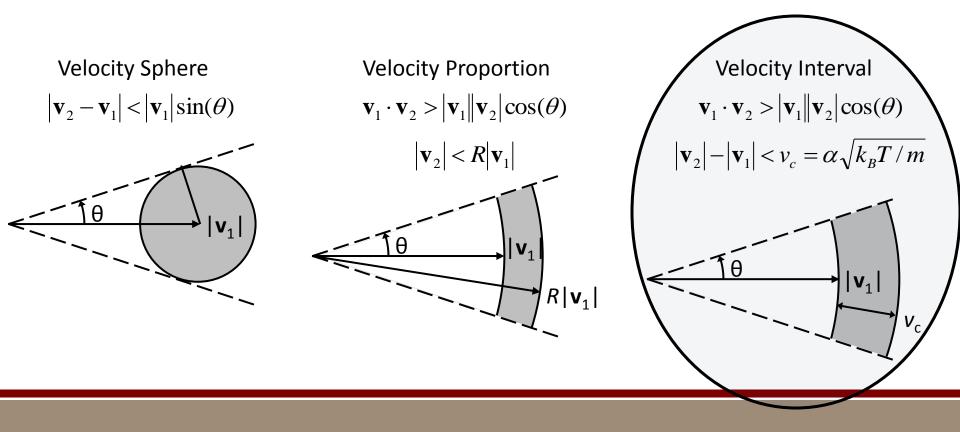
Managing p_{weight}: Particle Merging

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Only approve merge pairs that are close in both position and velocity.

- The spatial bin is the element, approves any pair.
- The velocity bin has many options. We use velocity interval, since it is easy to compute and adjusts based on local temperature.

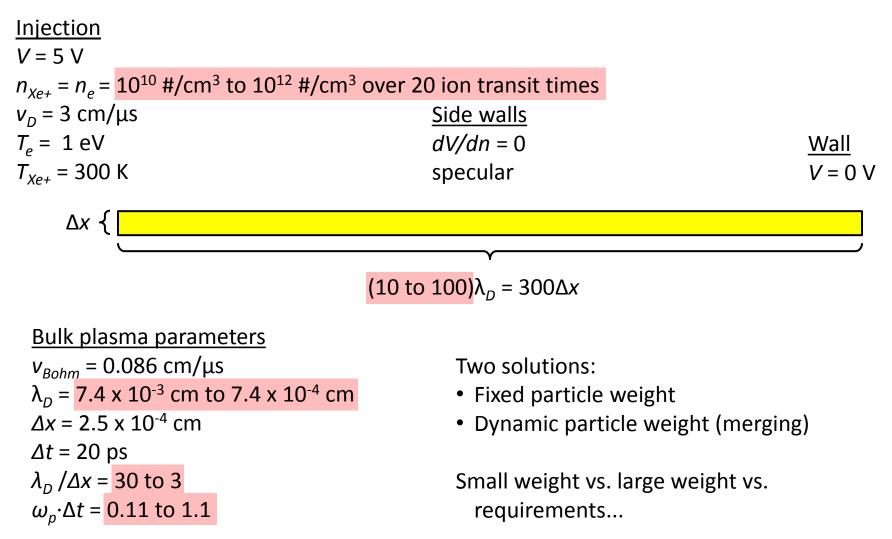
Much faster to sort particles in element by speed, then choose one at random and check neighbors for valid merge partner.



Managing p_{weight}: Particle Merging

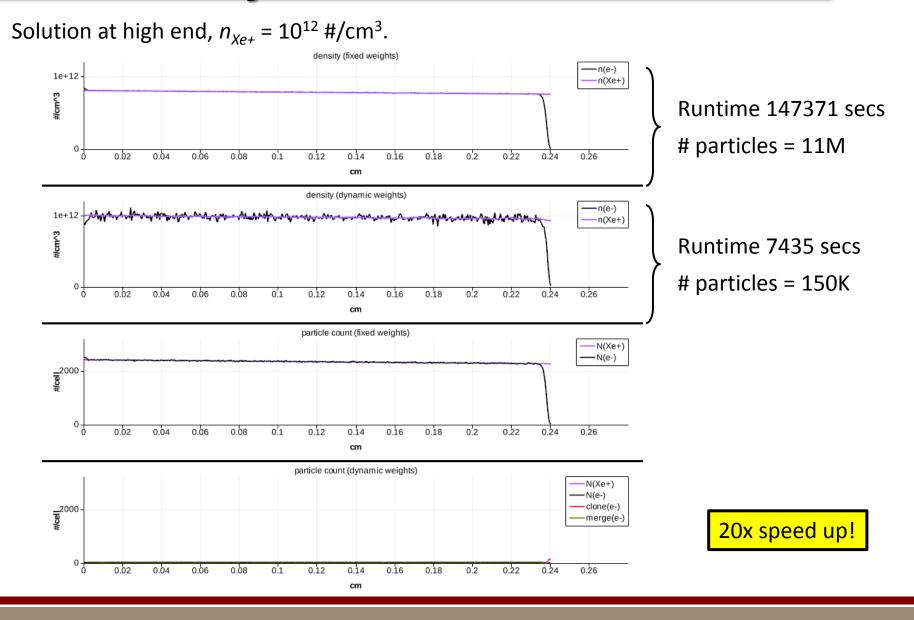


Example of using dynamic particle weighting is a growing Xenon sheath.



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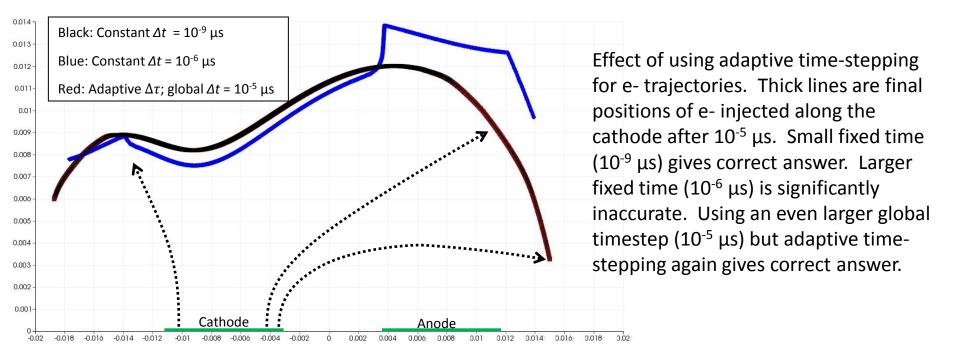
Managing p_{weight}: Particle Merging



Managing Δt: Explicit Adaptive Time-Stepping

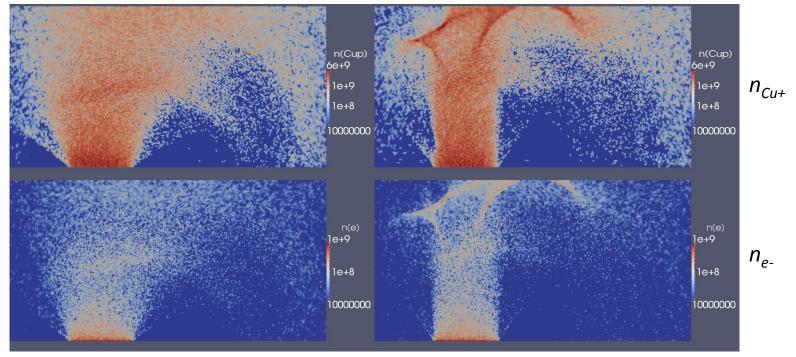
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In many initiation processes there is no significant space charge – only the initial applied field is relevant. In these cases we only need to accurately integrate particle trajectories. To mitigate the cost of using the most restrictive CFL-based Δt , we use a large "global" timestep Δt and force individual particles to use smaller adaptive timesteps { $\Delta \tau_{i,j}$ } within the global step ($\sum_{j} \Delta \tau_{i,j} = \Delta t$). $\Delta \tau_{i,j}$ is a function of particle velocity v_i , and the field **E** and field gradient $\nabla \mathbf{E}$ along the particle trajectory.

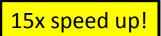


Managing ∆t: Explicit Adaptive Time-Stepping

2D domain with ~3 Torr background neutral gas – consistent with experiments. Small flux of e- from cathode, should ionize background gas. Ions can generate electrons at cathode. Run 3 cases out to $1.5 \times 10^{-3} \mu s$. Constant $\Delta t = 10^{-8} \mu s$ and adaptive $\Delta t = 10^{-5} \mu s$ results overlap.



Constant $\Delta t = 10^{-8} \,\mu s$ runtime 24.6 hours Adaptive $\Delta t = 10^{-5} \,\mu s$ runtime 1.6 hours (solutions essentially identical) Constant $\Delta t = 10^{-5} \ \mu s \ -- \ 0.024 \ hours$



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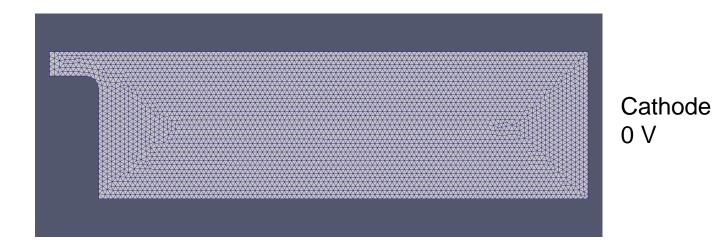
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Managing Δx: Dynamic Sizing of DSMC Cells



DSMC patch size is dynamically adjusted based on the local mean free path λ_{mfp} :

- 1. Compute λ_{mfp} for each interaction on an elemental basis (using all species)
- 2. For each interaction, average λ_{mfp} over elements in the oct-tree cell
- 3. Take the minimum of all the average λ_{mfp} and divide by 2, use this to size patches using the oct-tree algorithm



- Air injected at high velocity and high temperature from the anode
- Low density electrons injected from the cathode

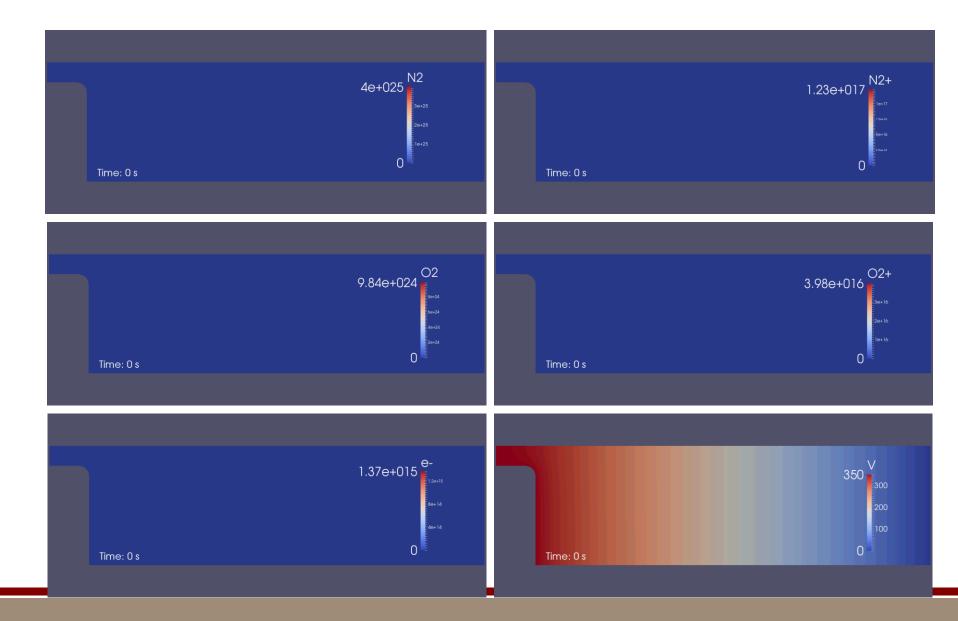
Anode

350 V

• Air ionizes and eventually will form plasma and break the gap

Managing Δx: Dynamic Sizing of DSMC Cells

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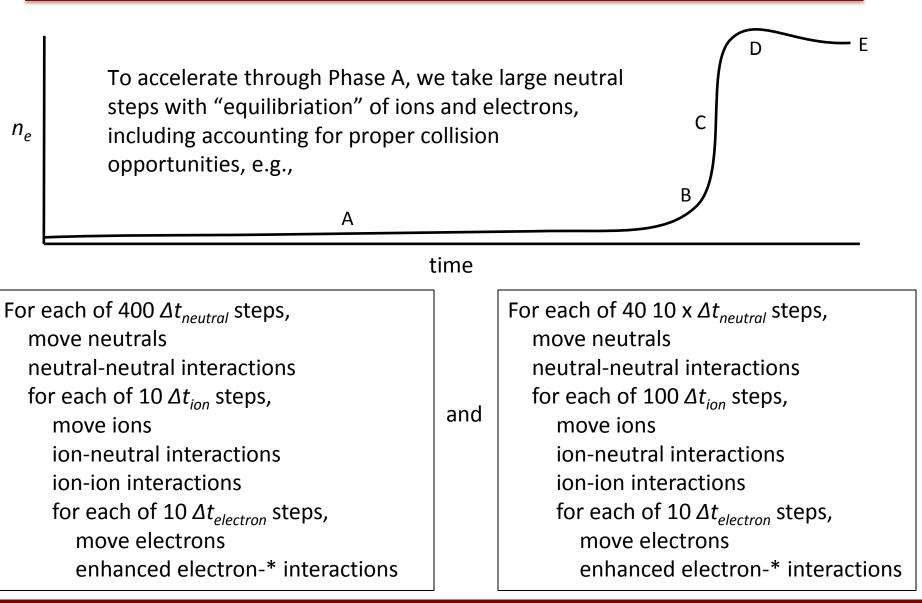
Managing Δx: Dynamic Sizing of DSMC Cells



Time: 0 s		

Time: 0 s	4e+025 ³⁰⁺²⁵ 10+25 0	20x speed up on "box" problem

Managing ∆t: Quasi-Static Acceleration

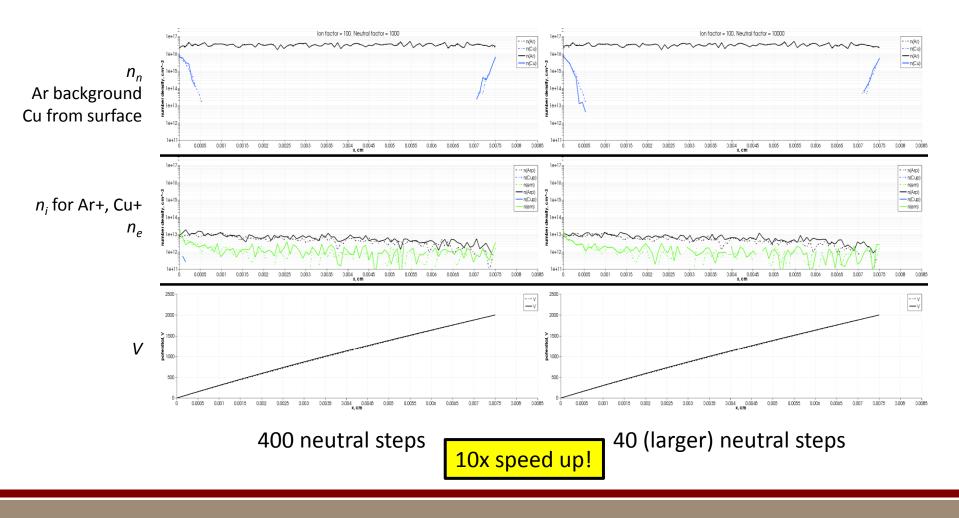




Managing ∆t: Quasi-Static Acceleration

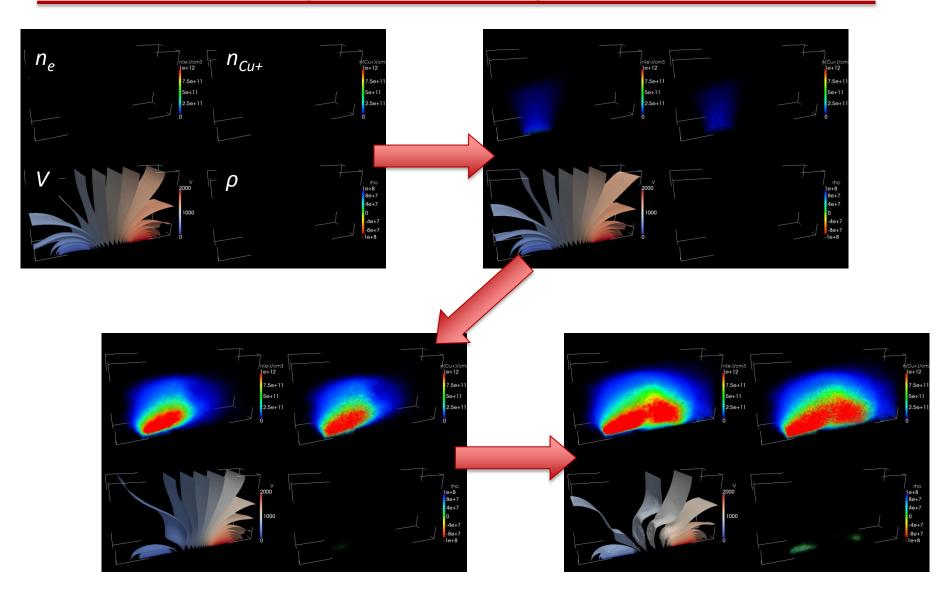
- Dashed lines are no acceleration.
- Neutral sputtering BC's.

- Cathode on left, anode on right.
- Influx of e- from cathode.

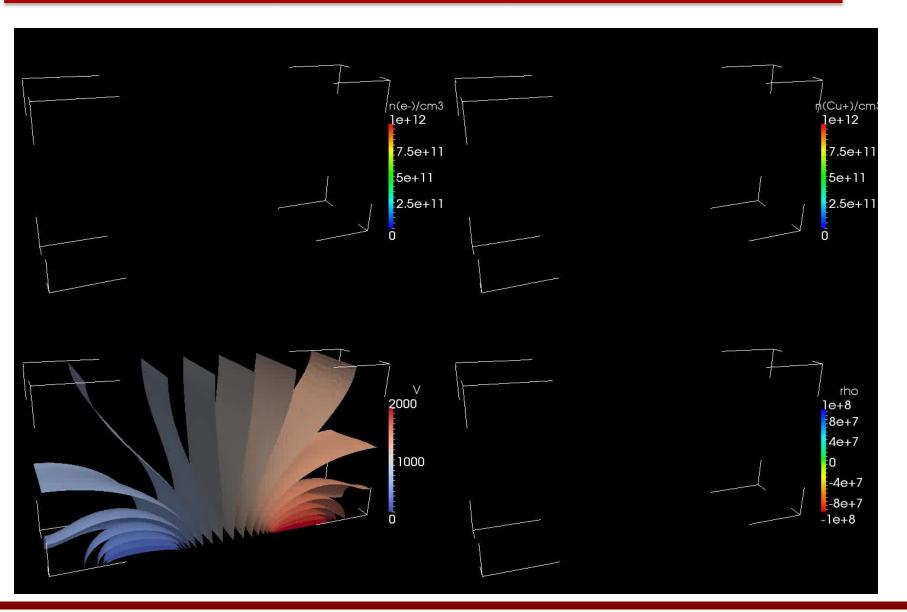


3D Simulation (Not Vacuum)





3D Simulation (Not Vacuum)





Conclusions & Other Pursuits



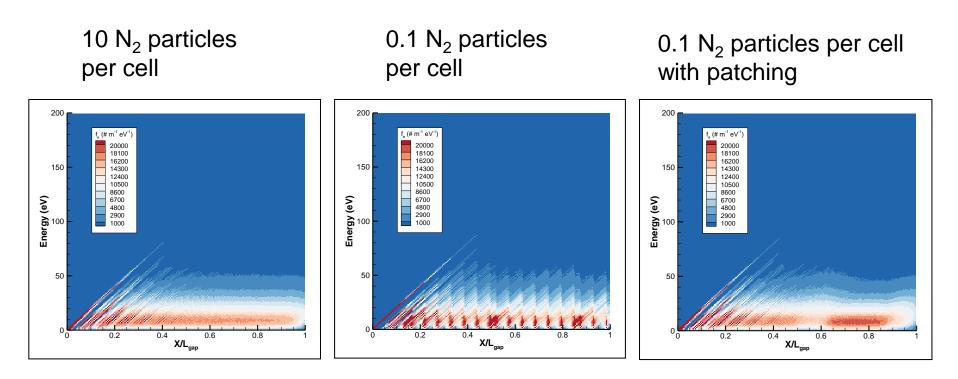
Simulating vacuum arcs is *extremely* expensive with vanilla PIC-DSMC methods. We are concurrently pursuing better physics models (not presented here) and more efficient algorithms with acceptable approximation errors to address these extreme simulation challenges.

Other areas we are pursing / have pursued include:

- Implicit kinetic methods
- Oct-tree DSMC collision mesh separate from PIC mesh
- Particle-Particle Particle-Mesh (P³M) methods
- Dynamic load balancing and other scaling improvements
- Stochastic cathode hot spot models
- Photoionization, photoemission

Electron Energy Distribution Function (EEDF)





- Using patching gives a more realistic EEDF (crucial for simulating accurate breakdown voltages)
- Patching allows one to use fewer N₂ particles